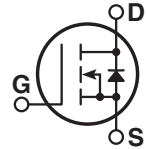
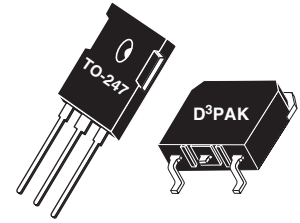




## Super Junction MOSFET

- Ultra Low  $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge,  $Q_g$
- Avalanche Energy Rated
- Extreme  $dv/dt$  Rated



### MAXIMUM RATINGS

All Ratings per die:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	APT30N60B_SC6	UNIT
$V_{DSS}$	Drain-Source Voltage	600	Volts
$I_D$	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	30	Amps
	Continuous Drain Current @ $T_C = 100^\circ\text{C}$	19	
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	89	
$V_{GS}$	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	$\pm 20$	Volts
$P_D$	Gate-Source Voltage Continuous	219	Watts
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	- 55 to 150	$^\circ\text{C}$
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	260	
$dv/dt$	Drain-Source Voltage slope ( $V_{DS} = 480\text{V}$ , $I_D = 30\text{A}$ , $T_J = 125^\circ\text{C}$ )	15	V/ns
$I_{AR}$	Avalanche Current <sup>2</sup>	5.2	Amps
$E_{AR}$	Repetitive Avalanche Energy <sup>2</sup> ( $I_D = 5.2\text{A}$ , $V_{DD} = 50\text{V}$ )	0.96	mJ
$E_{AS}$	Single Pulse Avalanche Energy ( $I_D = 5.2\text{A}$ , $V_{DD} = 50\text{V}$ )	636	

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{(DSS)}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$ )	600			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance <sup>3</sup> ( $V_{GS} = 10\text{V}$ , $I_D = 14.5\text{A}$ )		0.11	0.125	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 600\text{V}$ , $V_{GS} = 0\text{V}$ )			25	$\mu\text{A}$
	Zero Gate Voltage Drain Current ( $V_{DS} = 600\text{V}$ , $V_{GS} = 0\text{V}$ , $T_C = 150^\circ\text{C}$ )			100	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$ )			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 960\mu\text{A}$ )	2.5	3	3.5	Volts

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		2267		pF
$C_{oss}$	Output Capacitance			1990		
$C_{rss}$	Reverse Transfer Capacitance			203		
$Q_g$	Total Gate Charge <sup>4</sup>	$V_{GS} = 10V$ $V_{DD} = 300V$ $I_D = 30A @ 25^\circ C$		88		nC
$Q_{gs}$	Gate-Source Charge			12		
$Q_{gd}$	Gate-Drain ("Miller") Charge			46		
$t_{d(on)}$	Turn-on Delay Time	<b>INDUCTIVE SWITCHING</b> $V_{GS} = 15V$ $V_{DD} = 400V$ $I_D = 30A @ 25^\circ C$ $R_G = 4.3\Omega$		9		ns
$t_r$	Rise Time			17		
$t_{d(off)}$	Turn-off Delay Time			74		
$t_f$	Fall Time			48		
$E_{on}$	Turn-on Switching Energy <sup>5</sup>	<b>INDUCTIVE SWITCHING @ 25°C</b> $V_{DD} = 400V, V_{GS} = 15V$ $I_D = 30A, R_G = 4.3\Omega$		409		$\mu J$
$E_{off}$	Turn-off Switching Energy			224		
$E_{on}$	Turn-on Switching Energy <sup>5</sup>	<b>INDUCTIVE SWITCHING @ 125°C</b> $V_{DD} = 400V, V_{GS} = 15V$ $I_D = 30A, R_G = 4.3\Omega$		649		
$E_{off}$	Turn-off Switching Energy			282		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$I_S$	Continuous Source Current (Body Diode)		26		Amps
$I_{SM}$	Pulsed Source Current <sup>1</sup> (Body Diode)		65		Amps
$V_{SD}$	Diode Forward Voltage <sup>3</sup> ( $V_{GS} = 0V, I_S = -30A$ )			1.30	Volts
$dv/dt$	Peak Diode Recovery $dv/dt$ <sup>6</sup>		15		V/ns
$t_{rr}$	Reverse Recovery Time ( $I_S = -30A, di/dt = 100A/\mu s$ )	$T_J = 25^\circ C$	661		ns
		$T_J = 125^\circ C$	813		
$Q_{rr}$	Reverse Recovery Charge ( $I_S = -30A, di/dt = 100A/\mu s$ )	$T_J = 25^\circ C$	15		$\mu C$
		$T_J = 125^\circ C$	18		
$I_{RRM}$	Peak Recovery Current ( $I_S = -30A, di/dt = 100A/\mu s$ )	$T_J = 25^\circ C$	46		Amps
		$T_J = 125^\circ C$	48		

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.52	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			31	

- 1 Repetitive Rating: Pulse width limited by maximum junction temperature
- 2 Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV} = E_{AR} \cdot f$ . Pulse width tp limited by Tj max.
- 3 Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%
- 4 See MIL-STD-750 Method 3471
- 5 Eon includes diode reverse recovery.
- 6 Maximum 125°C diode commutation speed = di/dt 600A/ $\mu s$

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

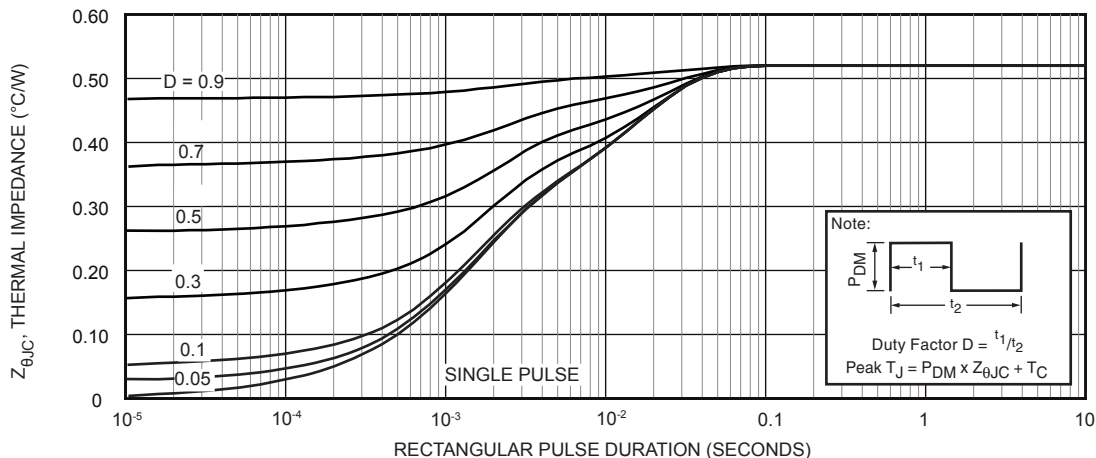


Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

Typical Performance Curves

APT30N60B\_SC6

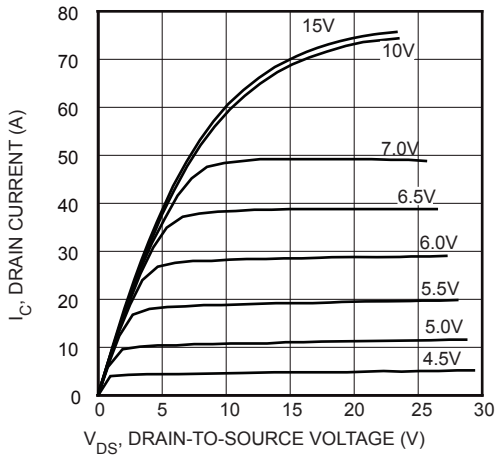


FIGURE 2, Low Voltage Output Characteristics

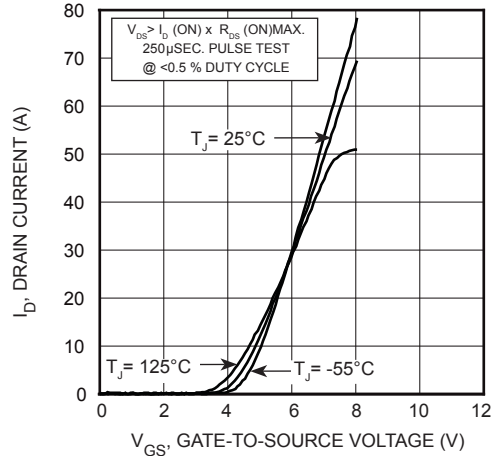


FIGURE 3, Transfer Characteristics

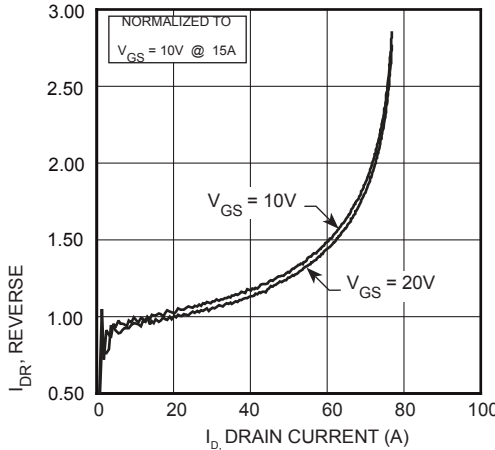


FIGURE 4,  $R_{DS}(ON)$  vs Drain Current

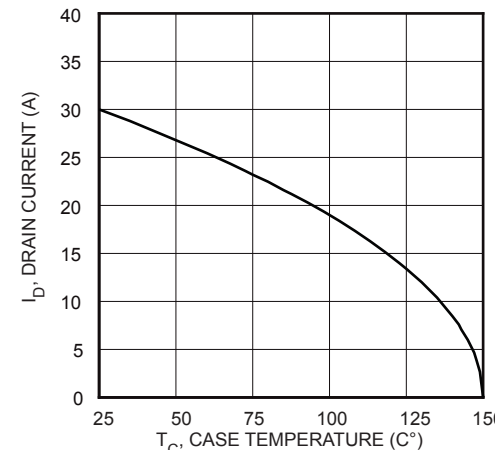


FIGURE 5, Maximum Drain Current vs Case Temperature

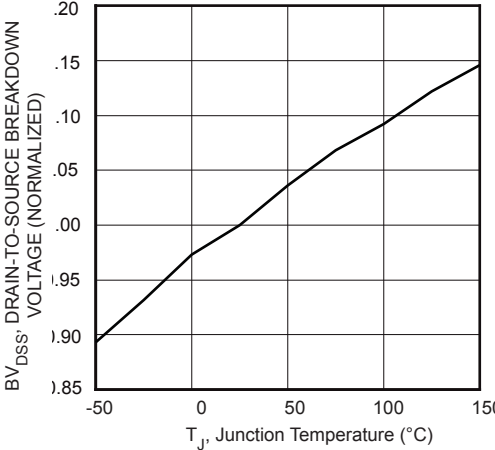


FIGURE 6, Breakdown Voltage vs Temperature

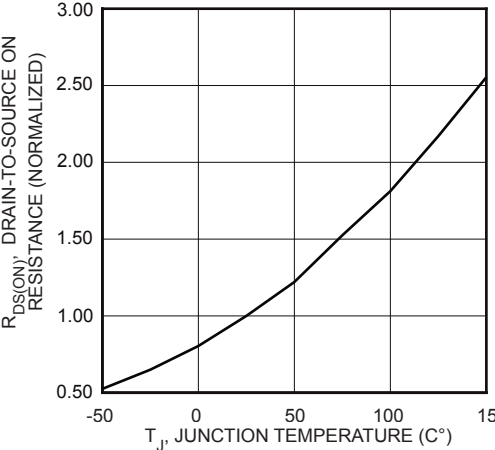


FIGURE 7, On-Resistance vs Temperature

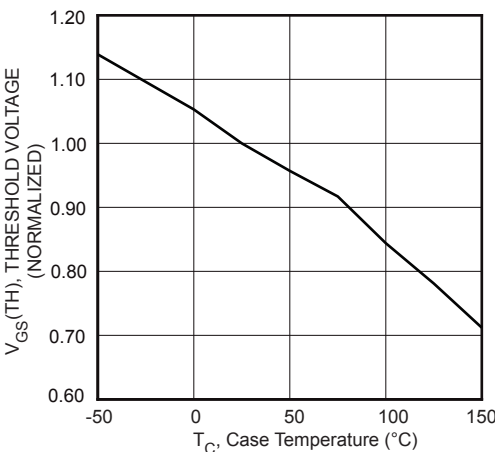


FIGURE 8, Threshold Voltage vs Temperature

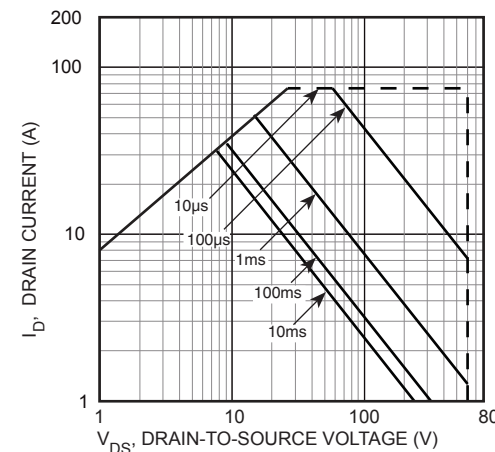


FIGURE 9, Maximum Safe Operating Area

# Typical Performance Curves

APT30N60B\_SC6

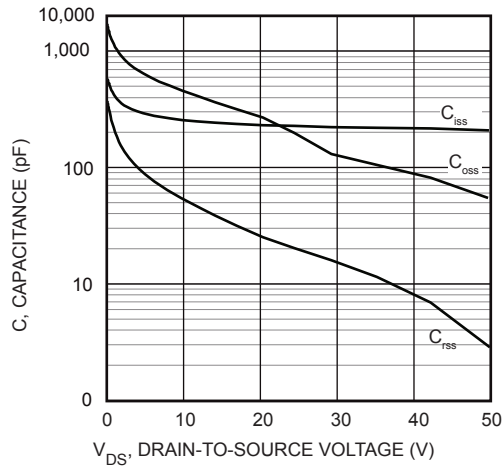


FIGURE 10, Capacitance vs Drain-To-Source Voltage

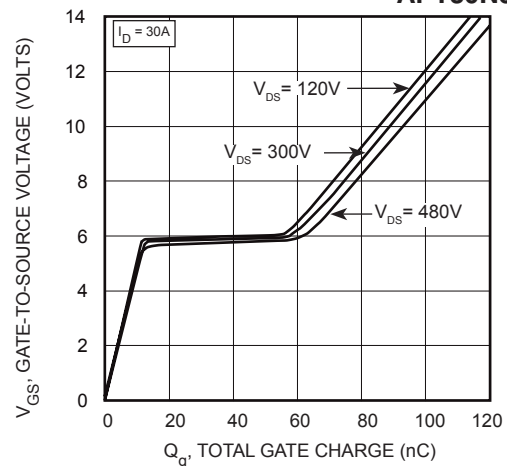


FIGURE 11, Gate Charges vs Gate-To-Source Voltage

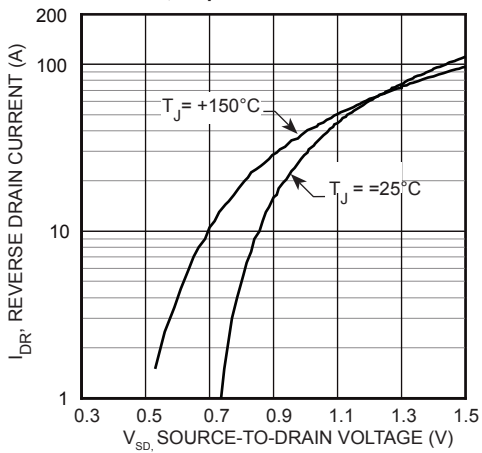


FIGURE 12, Source-Drain Diode Forward Voltage

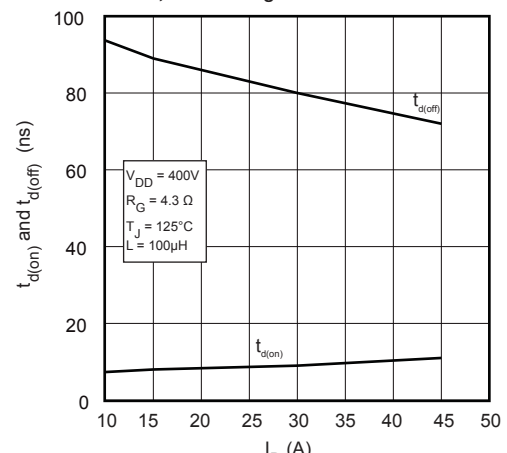


FIGURE 13, Delay Times vs Current

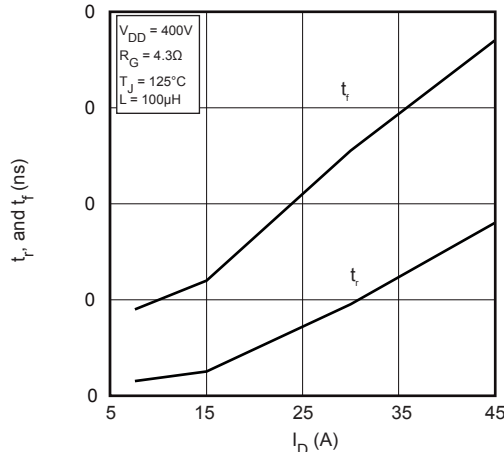


FIGURE 14, Rise and Fall Times vs Current

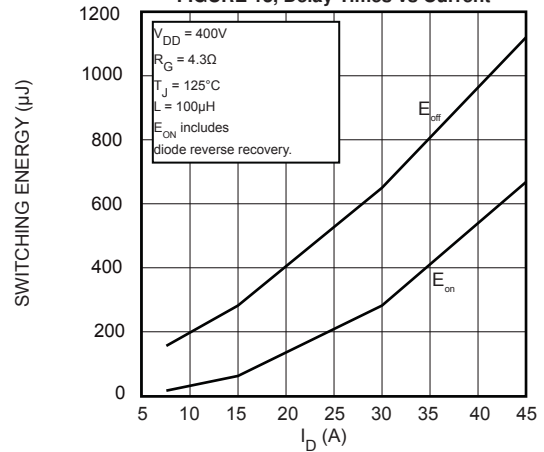


FIGURE 15, Switching Energy vs Current

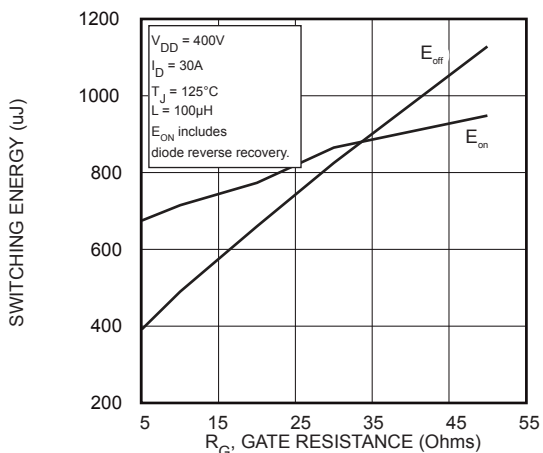


FIGURE 16, Switching Energy vs Gate Resistance

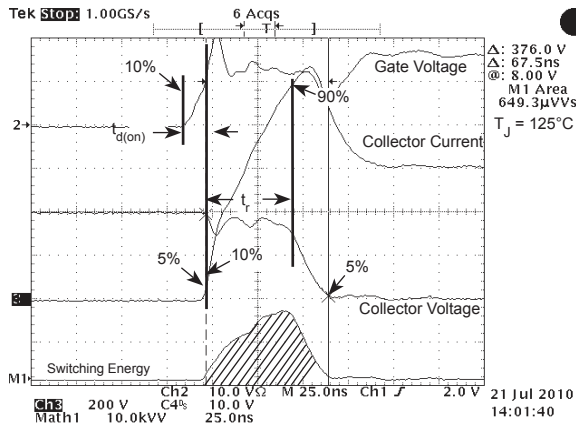


Figure 17, Turn-on Switching Waveforms and Definitions

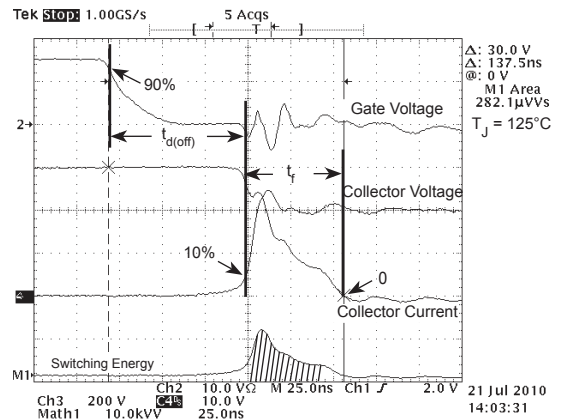


Figure 18, Turn-off Switching Waveforms and Definitions

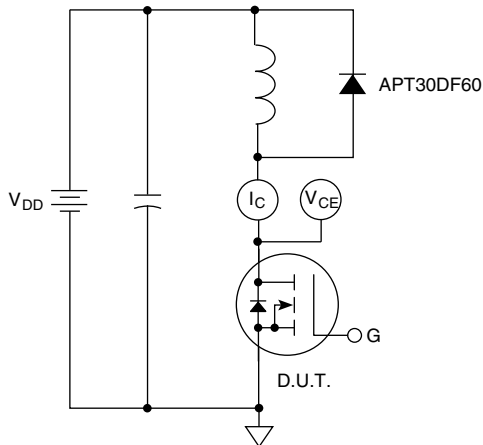
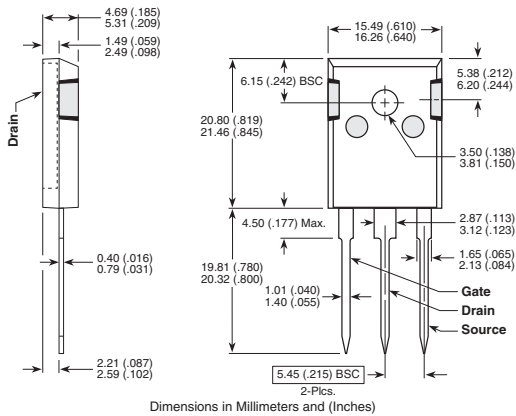


Figure 19, Inductive Switching Test Circuit

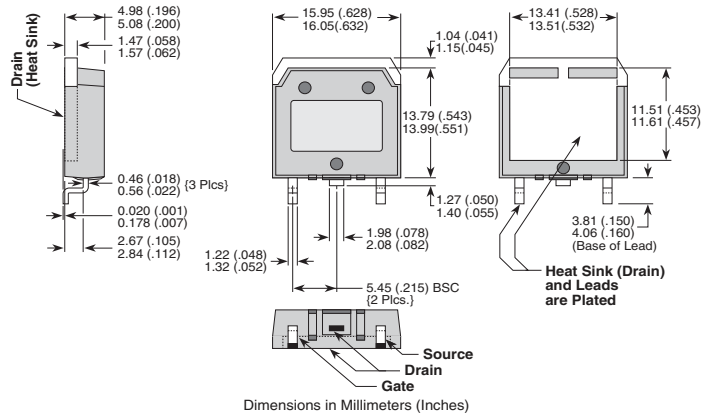
TO-247 Package Outline



Dimensions in Millimeters and (Inches)

D<sup>3</sup>PAK Package Outline

100% Sn



Dimensions in Millimeters (Inches)